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APPLICATION NO.	FILING DATE	FIRST NAMED	INVENTOR		ATTORNEY DOCKET NO.
09/308,620	07/20/99	TSUBOSAKI		K	501.37120X00
•			7 !	EXAMINER	
020457 ANTONELLI T SUITE 1800	ERRY STOUT	MM91/1017 AND KRAUS	[THAT . L	PAPER NUMBER
	SEVENTEENTH A 22209	STREET		2811 DATE MAILED	: 10/17/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

		Application No.	Applicant(s)
Office Action Summary		09/308,620	TSUBOSAKI ET AL.
		Examiner	Art Unit
		luan Thai	2811
	The MAILING DATE of this communication a	appears on the cover sheet	with the correspondence address
eriod for	Reply		
THE M - Extens after S - If the p - If NO - Failure	PRTENED STATUTORY PERIOD FOR REFIGILING DATE OF THIS COMMUNICATION is communication. It is communication. It is complete the provisions of 37 CFR IX (6) MONTHS from the mailing date of this communication. Period for reply specified above is less than thirty (30) days, a period for reply is specified above, the maximum statutory perion to reply within the set or extended period for reply will, by stapply received by the Office later than three months after the maximum dipatent term adjustment. See 37 CFR 1.704(b).	1.136(a). In no event, however, may reply within the statutory minimum of the dwill apply and will expire SIX (6) M	a reply be timely filed thirty (30) days will be considered timely. ONTHS from the mailing date of this communication. ARANDONED (35 U.S.C. § 133).
1)	Responsive to communication(s) filed on _	·	
2a)⊠	This action is FINAL . 2b)□	This action is non-final.	
3)	Since this application is in condition for all closed in accordance with the practice unc	owance except for formal r der <i>Ex parte Quayle</i> , 1935	matters, prosecution as to the merits is C.D. 11, 453 O.G. 213.
	on of Claims		
4)⊠	Claim(s) 1-11 and 13-32 is/are pending in	the application.	
	4a) Of the above claim(s) <u>3,10 and 15-32</u> is	/are withdrawn from consid	deration.
	Claim(s) is/are allowed.		
6)⊠	Claim(s) 1-2, 4-9, 11, and 13-14 is/are reje	cted.	
7)	Claim(s) is/are objected to.		
8)[Claim(s) are subject to restriction ar	nd/or election requirement.	
	ion Papers		
9)[]	The specification is objected to by the Exan	niner.	
10)	The drawing(s) filed on is/are: a)□ a	accepted or b) 🔲 objected to	by the Examiner.
	Applicant may not request that any objection	to the drawing(s) be held in a	beyance. See 37 CFR 1.85(a).
11)	The proposed drawing correction filed on $_$	is: a)□ approved b)l	disapproved by the Examiner.
	If approved, corrected drawings are required	in reply to this Office action.	
12)	The oath or declaration is objected to by th	e Examiner.	<u> </u>
Priority	under 35 U.S.C. §§ 119 and 120		;
13)	Acknowledgment is made of a claim for fo	reign priority under 35 U.S	s.C. § 119(a)-(d) or (f).
	☐ All b)☐ Some * c)☐ None of:		•
,	1. Certified copies of the priority docur	ments have been received	•
	2 Certified copies of the priority docur	ments have been received	in Application No
	3. Copies of the certified copies of the	priority documents have b al Bureau (PCT Rule 17.2)	peen received in this National Stage (a)).
*	See the attached detailed Office action for	a list of the certified copies	TIOU TECEIVEU.
14)[]	Acknowledgment is made of a claim for dor	mestic priority under 35 U.S	S.C. § 119(e) (to a provisional application)
	a) The translation of the foreign languag Acknowledgment is made of a claim for do	e provisional application h	as been received.
Attachme			
1) Not	ice of References Cited (PTO-892) ice of Draftsperson's Patent Drawing Review (PTO-94 rmation Disclosure Statement(s) (PTO-1449) Paper N	18) 5) 🔲 Noti	rview Summary (PTO-413) Paper No(s) ice of Informal Patent Application (PTO-152) er:

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DETAILED ACTION

This Office action is responsive to the amendment filed August 14, 2001.

Claims 1-11 and 13-32 are pending in this application.

Claims **3, 10**, and **15-32**, have been withdrawn from consideration as being directed to a non-elected invention.

Claim 12 has been canceled.

Claim Objections

1. Claim 7 is objected to because of the following informalities: the limitation of "said passage" in claim 7 (line 4) should be changed to –said seal resin injection port—. Appropriate correction is required.

Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 3. Claims 1-2, 4-9, 11, and 13-14 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

The phrase "characterized in that said back surface of said semiconductor chip is defined by spin-etching a surface opposite to said semiconductor chip so that, etc." in the amended claim 1 is unclear as to how "a surface" opposite to "a semiconductor chip" can be defined.

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Claims 2, 4-9, 11, and 13-14 are rejected since each includes the limitations of independent claim 1.

Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 1-2, 4-8, 11, and 14, insofar as in compliance with 35 USC § 112, are rejected under 35 U.S.C. 103(a) as being unpatentable over Haghiri-Tehrani et al. (4,829,666 of record).

Regarding claims 1, 4, and 11, Haghiri-Tehrani et al.'s figures 1-5 show a semiconductor device including a semiconductor chip 4 having a principal surface and a back surface, opposite to the principal surface, disposed in a device hole 3 provided in a tape carrier 1 with one end of a lead 5 on the tape carrier being electrically connected to an external terminal of the chip 4, characterized in that the chip 4 is less in thickness than the tape carrier 1 (see figures 2-3), and that the chip is sealed by a seal resin material 7 so that the principal surface and the back surface of the chip are covered with the seal resin material 7, and that the seal resin material 7 has its upper and lower surfaces substantially identical in level to upper and lower surfaces of the tape carrier 1

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(see figures 2-5). Haghiri-Tehrani et al. fail to teach the back surface of the chip is defined (or polished) by spin-etching technique.

However, Applicant's claims 1, 4, and 11 do not distinguish over the device of Haghiri-Tehrani et al. as detailed above regardless of the process used to polish a chip, because only the final product is relevant, not the process of making such as "polished by a spin etching technique". Note that a "product by process" claim is directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See also In re Brown, 173 USPQ 685; In re Luck, 177 USPQ 523; In re Fessmann, 180 USPQ 324; In re Avery, 186 USPQ 161; In re Wertheim, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); and In re Marrosi et al., 218 USPQ 289, all of which make it clear that it is the patentability of the final product per se which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims or not. Note that applicant has the burden of proof in such cases, as the above case law makes clear. See also MPEP 706.03(e).

Regarding claim 2, although Haghiri-Tehrani et al.'s reference does not specifically disclose a stress neutral plane extending parallel to the principal surface of the chip at a position along the thickness direction of the tape carrier, this feature is taken to be inherent in Haghiri-Tehrani et al.'s device since the claimed structure is identical to Haghiri-Tehrani et al.'s device which comprises a

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chip being sealed by a seal resin material so that the principal surface and the back surface of the chip are covered with the seal resin material, and that the seal resin material has its upper and lower surfaces substantially identical in level to upper and lower surfaces of the tape carrier (see figures 1-3).

Regarding claims 5, 6, and 8, the proposed device of Haghiri-Tehrani et al. discloses all the limitations of the claimed invention as detailed above except for the tape carrier having a seal resin injection port or an air exhaust port for use in seal resin injection or during formation of the resin seal. Although Haghiri-Tehrani et al. fail to teach the tape carrier having a seal resin injection port or an air exhaust port for use in seal resin injection process, the final product of Haghiri-Tehrani et al. does not distinguish over the claimed structure of claim 5 regardless of the process used (e.g., with or without a seal resin injection port or an air exhaust port) to form the sealing resin for the device because only the final product is relevant, not the process of making such as using a seal resin injection port or an air exhaust port for the seal resin injection process. Note that a "product by process" claim is directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See also In re Brown, 173 USPQ 685; In re Luck, 177 USPQ 523; In re Fessmann, 180 USPQ 324; In re Avery, 186 USPQ 161; In re Wertheim, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); and In re Marrosi et al., 218 USPQ 289, all of which make it clear that it is the patentability of the final product per se which must be determined in a "product by process" claim, and not the patentability of

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the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims or not. Note that applicant has the burden of proof in such cases, as the above case law makes clear. See also MPEP 706.03(e).

Regarding claim 7, the proposed device of Haghiri-Tehrani et al. discloses all the limitations of the claimed invention (including a metal layer 3) as detailed above except for specifying the metal layer being an electroplated metal layer. Forming an electroplated metal layer on a tape carrier or a film carrier is conventional in semiconductor art. It would have been obvious to a person having skill in the art at the time the invention was made to form an electroplated metal layer on the tape carrier of the proposed device of Haghiri-Tehrani et al, since it has been held to be within the general skill of a worker in the art to select a known technique on the basis of its suitability for the intended use as a matter of obvious design choice. *In re Leshin*, 125 USPQ 416.

Regarding claim 14, Haghiri-Tehrani et al. disclose all the limitations of the claimed invention, including one end of the lead is directly coupled to the external terminal of the chip, as detailed above except for one end of the lead being electroplated. Electroplating is a well known technique in semiconductor art for simplifying the process of making electrical connections between a metal lead and an external terminal on a chip. It would have been obvious to one of ordinary skill in the art at the time the invention was made to apply electroplating

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to one end of the lead of Haghiri-Tehrani et al.'s device in order to simplify the process of making electrical connections in the device.

6. Claims 9 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Haghiri-Tehrani et al. (4,829,666 of record) in view of Nakamura (5,729,051 of record).

Regarding claim 9, Haghiri-Tehrani et al. disclose all the limitations of the claimed invention as detailed above except for a bump electrode formed at the remaining end of the lead. Nakamura while relates to a similar package design teaches a bump electrode 5 being formed at the remaining end of the lead 3 for forming an electrically interconnect between the device and a mounting board. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use a gold bump as taught by Nakamura for forming electrical connection between the device and the mounting board.

Regarding claim 13, Haghiri-Tehrani et al. disclose all the limitations of the claimed invention as detailed above except for a gold bump electrode at the external electrode of the chip. Nakamura while relates to a similar package design teaches a gold bump electrode form on the external terminal of the chip for making electrical connection with the lead. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use gold bumps as taught by Nakamura to construct electrical connections between the chip external terminal and the lead in Haghiri-Tehrani et al.'s device.

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7. Claims 5-8, insofar as in compliance with 35 USC § 112, are rejected under 35 U.S.C. 103(a) as being unpatentable over Haghiri-Tehrani et al. (4,829,666 of record) in view of Ueda et al. (5,196,917 of record).

Regarding claim 5, Haghiri-Tehrani et al. disclose all the limitation of the claimed invention as detailed above except for the tape carrier having a seal resin injection port for use in seal resin injection. Ueda et al. while relate to a similar structure design teach (figures 1-9) a passage 14 used in seal resin injection being formed at part of the tape carrier 1 thereby causing the device hole 3 to be coupled to a gate 17 of a metal mold structure 10 used during formation of the seal resin. It would have been obvious to one of ordinary skill in the art at the time the invention was make to apply Ueda et al.'s teachings to Haghiri-Tehrani et al.'s device in order to perform the process of encapsulating the device.

Regarding claim 7, the proposed device of Haghiri-Tehrani et al. and Ueda et al. discloses all the limitations of the claimed invention (including a metal layer 3) as detailed above except for specifying the metal layer being an electroplated metal layer. Forming an electroplated metal layer on a tape carrier or a film carrier is conventional in semiconductor art. It would have been obvious to a person having skill in the art at the time the invention was made to form an electroplated metal layer on the tape carrier of the proposed device of Haghiri-Tehrani et al, since it has been held to be within the general skill of a worker in

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the art to select a known technique on the basis of its suitability for the intended use as a matter of obvious design choice. *In re Leshin*, 125 USPQ 416.

Regarding claims 6 and 8, the proposed device of Haghiri-Tehrani et al. and Ueda et al. discloses all the limitations of the claimed invention (including an air exhaust port 15 or 25, 35) as detailed above except for the metal mold structure having an air vent. An air vent forming in a mold is very conventional in semiconductor art, especially in semiconductor molding art, for allowing air to escape during formation of encapsulated injection. It would have been obvious to one of ordinary skill in the art at the time the invention was made to form an air vent on the tape carrier of the proposed device of Haghiri-Tehrani et al. and Ueda et al. for air to escape during encapsulated injection.

Conclusion

- 8. Applicant's arguments with respect to claims **1-2**, **4-9**, **11** and **13-14** have been fully considered, but they are deemed to be moot in view of the new grounds of rejection.
- 9. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action because the underlined portions of claims 1 and 5 raise new issues that would require further consideration and/or search. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within

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TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Luan Thai whose telephone number is (703) 308-1211. The examiner can normally be reached on 7:00 AM - 3:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on (703) 308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Luan Thai October 13, 2001 TOM THOMAS SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800